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PATENT  
8007-1111

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Atsushi SAKURAI et al. Conf. 1454

Application No. 10/583,942 Group 2812

Filed: June 22, 2006 Examiner Michael Lebentritt

Title: METAL COMPOUND, MATERIAL FOR  
THIN FILM FORMATION, AND PROCESS  
OF FORMING THIN FILM

SUPPLEMENTAL PRELIMINARY AMENDMENT

Assistant Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

May 16, 2007

Sir:

In response to the Notice of Non-Compliant Amendment mailed April 25, 2007, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 6 of this paper.